

Short-Pulse Dense Wavelength-Division-Multiplexed Optical Interconnects

David A. B. Miller and James S. Harris Jr.

Stanford University

<http://ee.stanford.edu/~dabm>



David A. B. Miller, Stanford

Report Documentation Page				Form Approved OMB No. 0704-0188	
Public reporting burden for the collection of information is estimated to average 1 hour per response, including the time for reviewing instructions, searching existing data sources, gathering and maintaining the data needed, and completing and reviewing the collection of information. Send comments regarding this burden estimate or any other aspect of this collection of information, including suggestions for reducing this burden, to Washington Headquarters Services, Directorate for Information Operations and Reports, 1215 Jefferson Davis Highway, Suite 1204, Arlington VA 22202-4302. Respondents should be aware that notwithstanding any other provision of law, no person shall be subject to a penalty for failing to comply with a collection of information if it does not display a currently valid OMB control number.					
1. REPORT DATE 18 APR 2000		2. REPORT TYPE N/A		3. DATES COVERED -	
4. TITLE AND SUBTITLE Short-Pulse Dense Wavelength-Division-Multiplexed Optical Interconnects				5a. CONTRACT NUMBER	
				5b. GRANT NUMBER	
				5c. PROGRAM ELEMENT NUMBER	
6. AUTHOR(S)				5d. PROJECT NUMBER	
				5e. TASK NUMBER	
				5f. WORK UNIT NUMBER	
7. PERFORMING ORGANIZATION NAME(S) AND ADDRESS(ES) Stanford University				8. PERFORMING ORGANIZATION REPORT NUMBER	
9. SPONSORING/MONITORING AGENCY NAME(S) AND ADDRESS(ES)				10. SPONSOR/MONITOR'S ACRONYM(S)	
				11. SPONSOR/MONITOR'S REPORT NUMBER(S)	
12. DISTRIBUTION/AVAILABILITY STATEMENT Approved for public release, distribution unlimited					
13. SUPPLEMENTARY NOTES DARPA/MTO, WDM for Military Platforms Workshop held in McLean, VA on April 18-19, 2000, The original document contains color images.					
14. ABSTRACT					
15. SUBJECT TERMS					
16. SECURITY CLASSIFICATION OF:			17. LIMITATION OF ABSTRACT UU	18. NUMBER OF PAGES 31	19a. NAME OF RESPONSIBLE PERSON
a. REPORT unclassified	b. ABSTRACT unclassified	c. THIS PAGE unclassified			

Summary

WDM interconnects between silicon chips

- short-pulse WDM
- dense receiver/transmitter arrays

Synchronization with short pulses

- data resynchronization
 - *skew and jitter removal*

Ultrafast optoelectronic gate

- possible time-division demultiplexing and wavelength conversion component,
 - *controllable by electronics*

GaInAsN for high uniformity long-wavelength devices

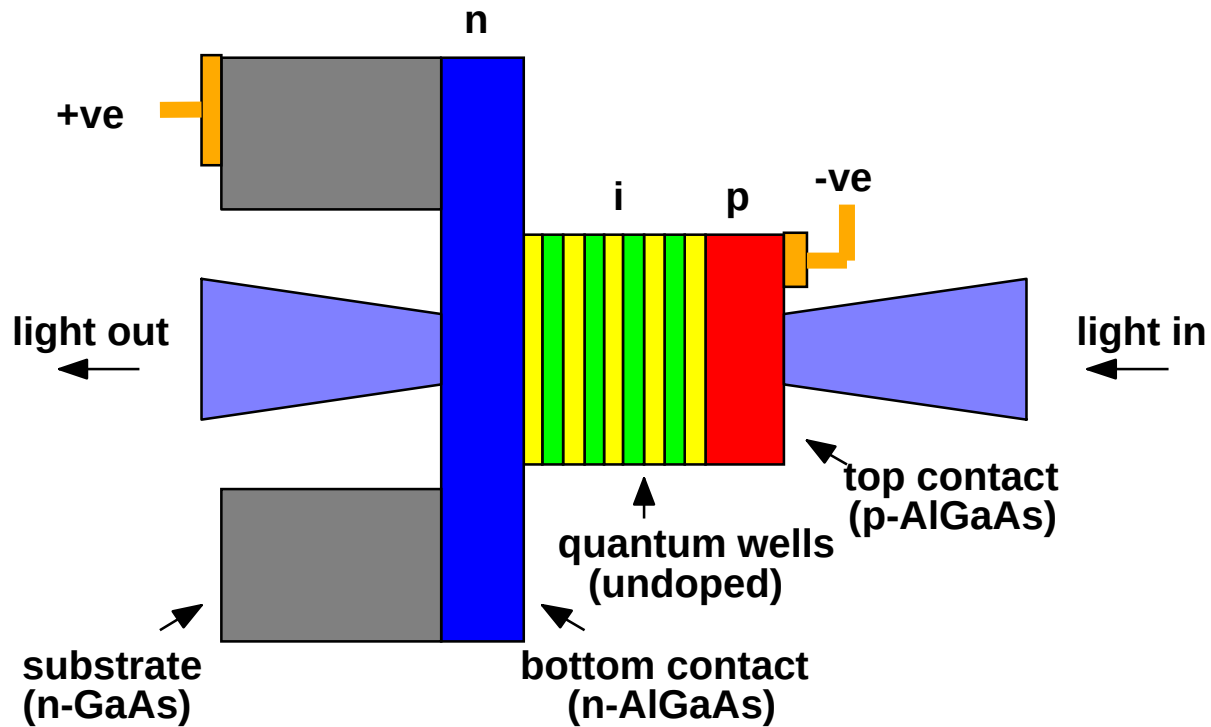
- unity sticking coefficient of N should allow high uniformity devices for long wavelengths
- potentially usable in long wavelength WDM systems

Modulator-Based Interconnects

quantum well reflective modulators

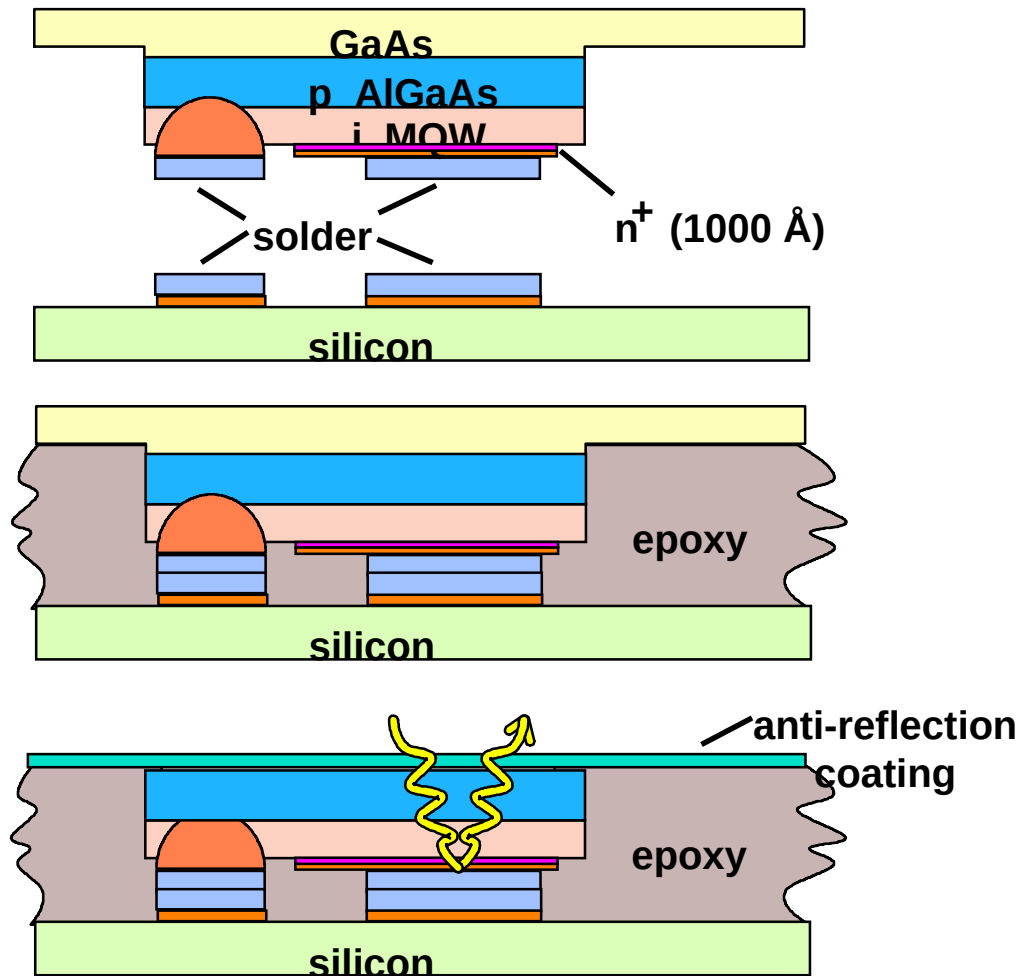
- solder bonded to silicon integrated circuits
- can function either as photodetector or output modulator (depending on circuit)
- can be made successfully in large numbers
- can be used with short pulse sources
- can be used with WDM sources (usable range ~ 6 - 10 nm)

Quantum Well Modulator



David A. B. Miller, Stanford

Quantum Well Modulators Solder-Bonded to Silicon Circuits - Hybrid SEED (Self Electro-optic Effect Device)

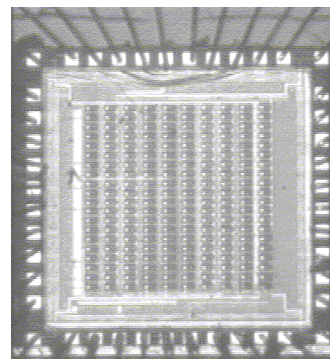
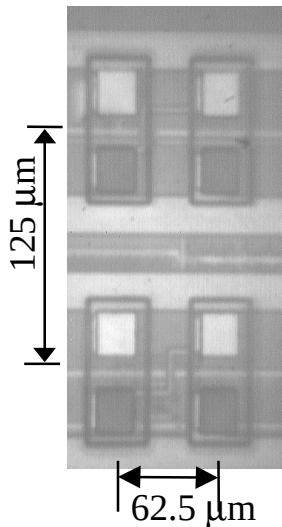
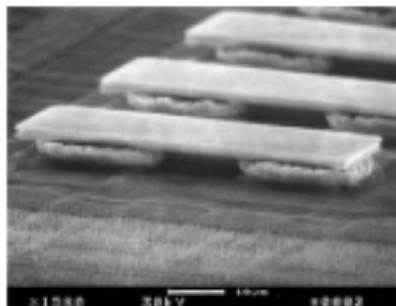


K. W. Goossen et al.,
IEEE Photonics Tech.
Lett. 7, 360 - 362
(1995)

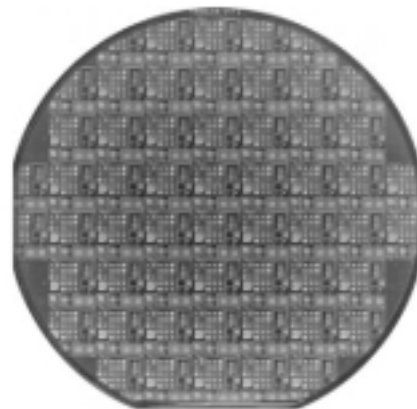
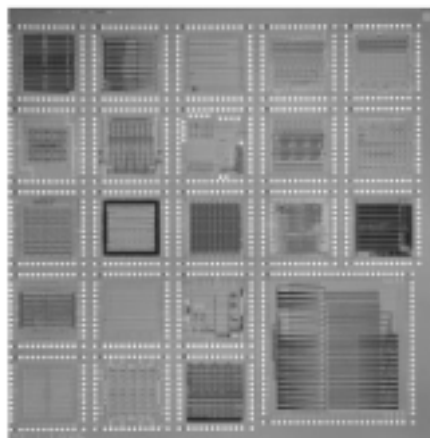
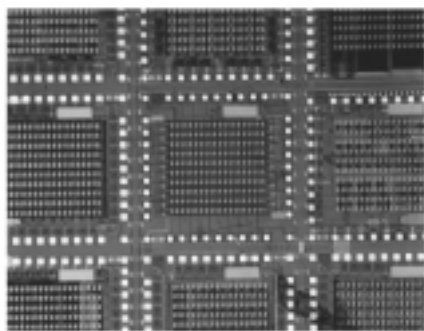
David A. B. Miller, Stanford

APPROVED FOR PUBLIC RELEASE, DISTRIBUTION UNLIMITED

Bell Labs Multiproject OE-VLSI Wafer



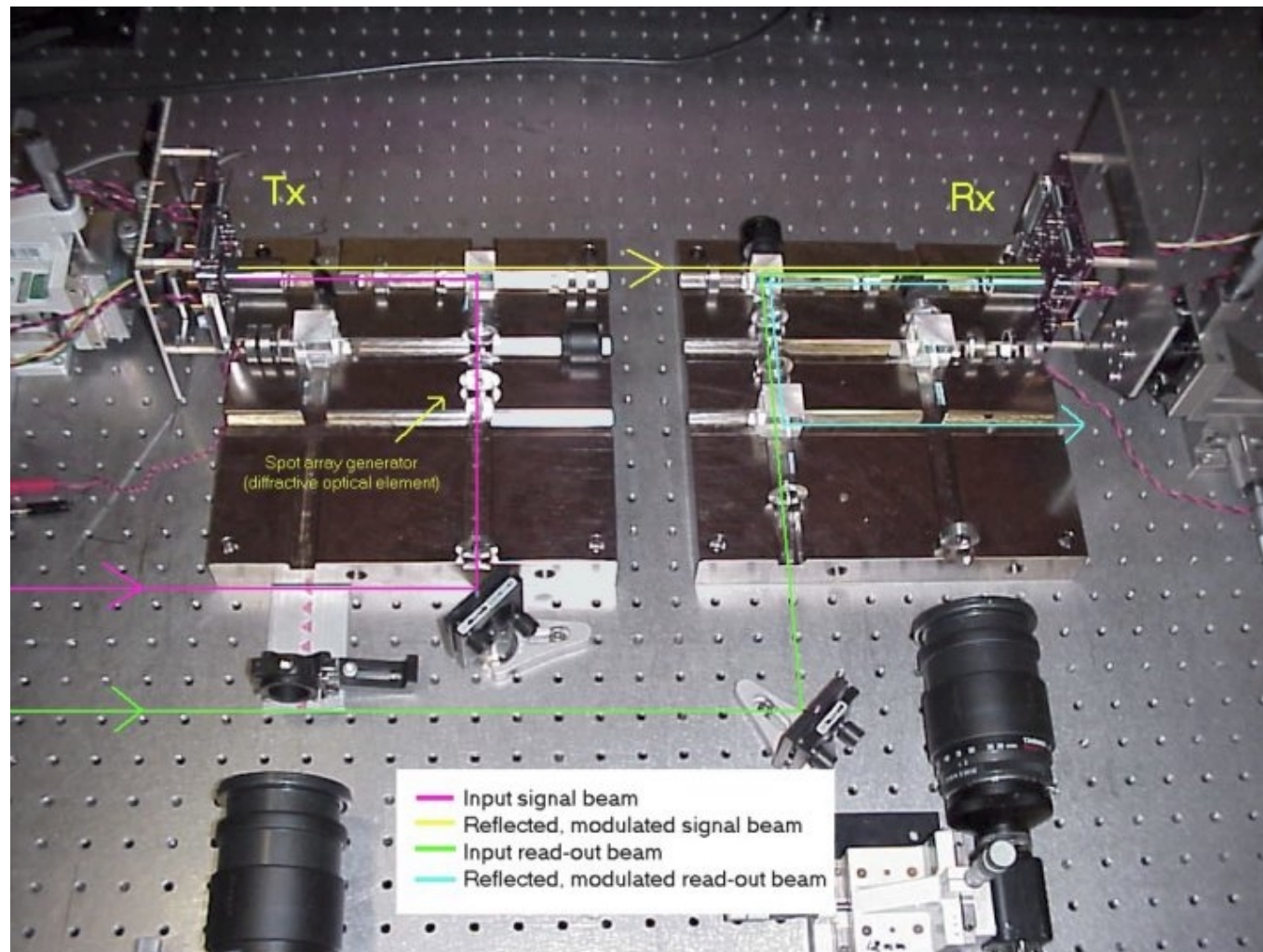
Arrays of solder-bonded multiple quantum well modulator/detector diodes on 0.5 μm Si CMOS



A. V. Krishnamoorthy and K. W. Goossen, IEEE J. Sel. Top. Quantum Electronics 4, 899 (1998)

David A. B. Miller, Stanford

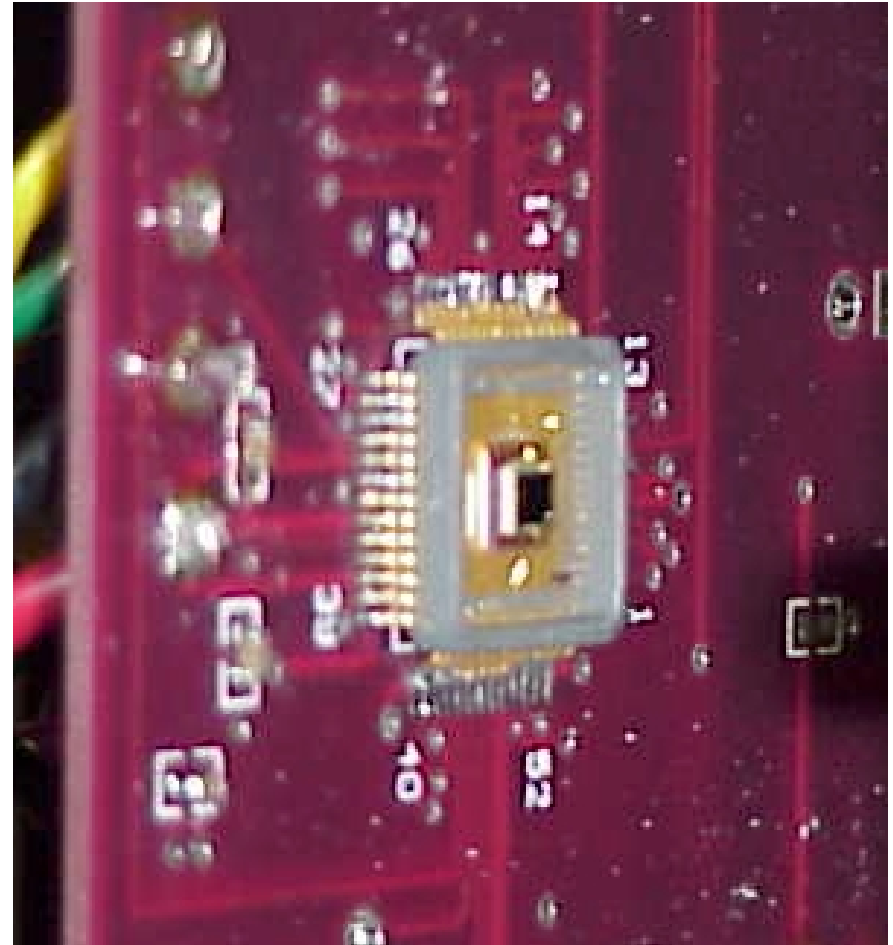
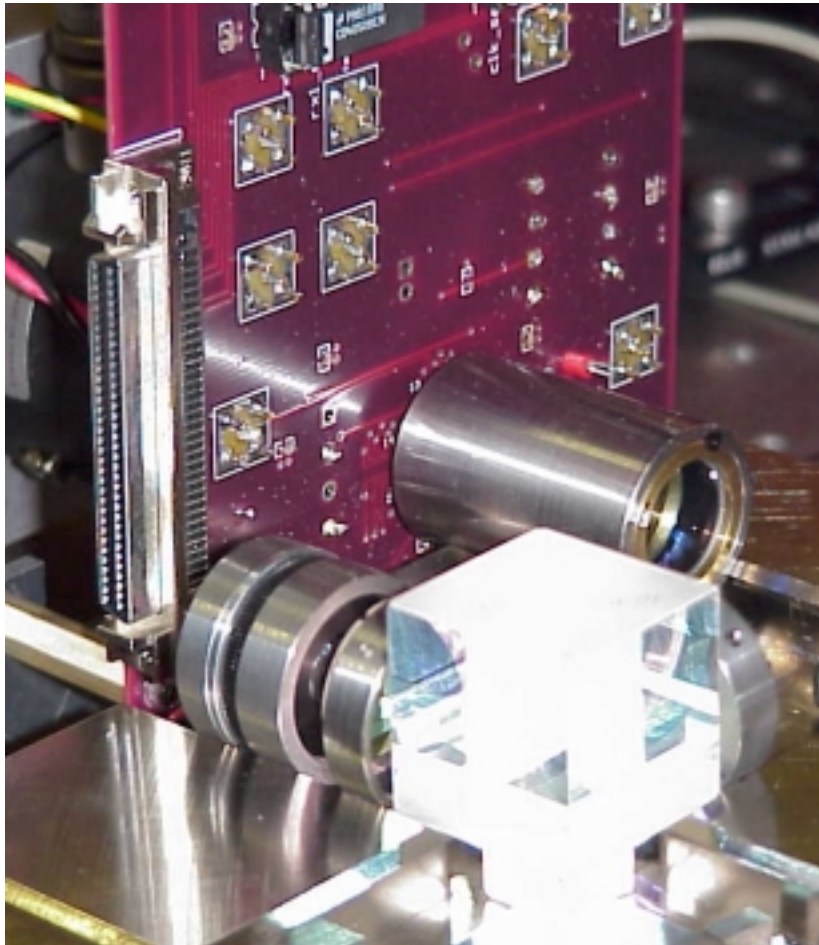
Baseplate Testing Setup



David A. B. Miller, Stanford

APPROVED FOR PUBLIC RELEASE, DISTRIBUTION UNLIMITED

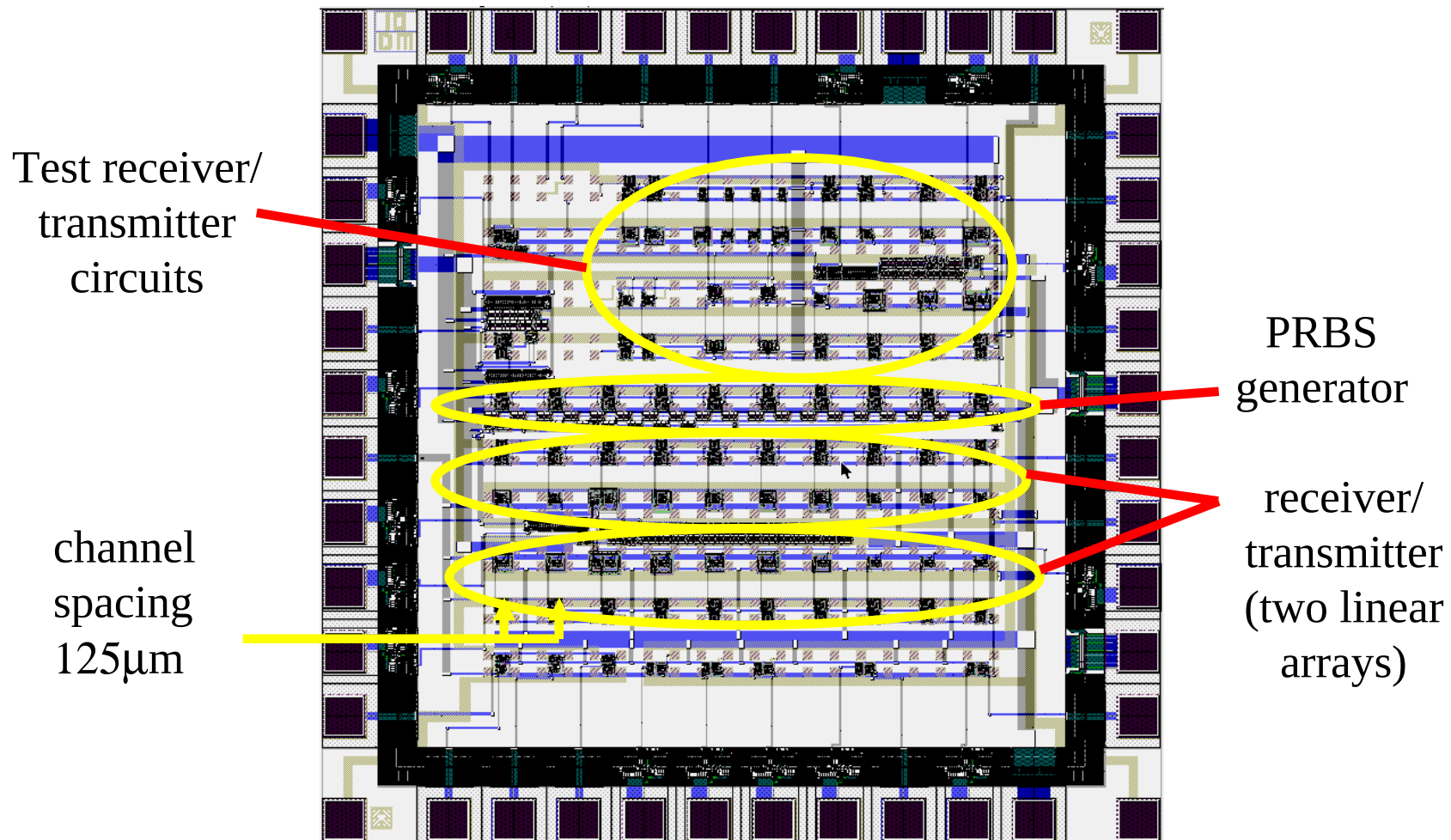
Close-up of Transmitter



David A. B. Miller, Stanford

APPROVED FOR PUBLIC RELEASE, DISTRIBUTION UNLIMITED

Chip Details



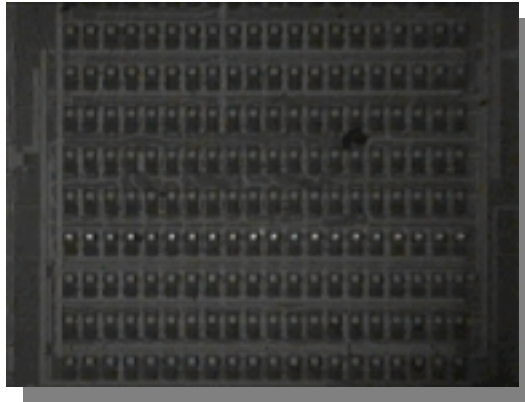
David A. B. Miller, Stanford

APPROVED FOR PUBLIC RELEASE, DISTRIBUTION UNLIMITED

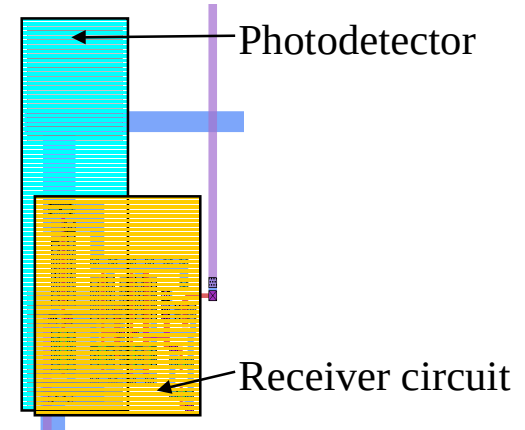
Example linear array optical interconnect

Transmitter chip

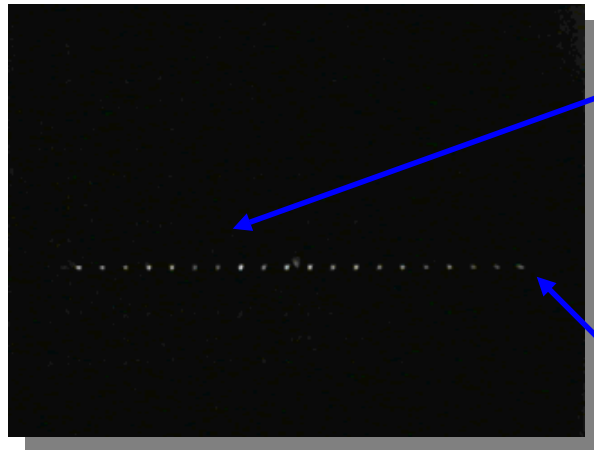
Modulator array operating with readout beams from spot array generator



Receiver layout



Receiver chip



Test optical readout from modulators connected to receiver circuit outputs

Modulated optical inputs from transmitter chip

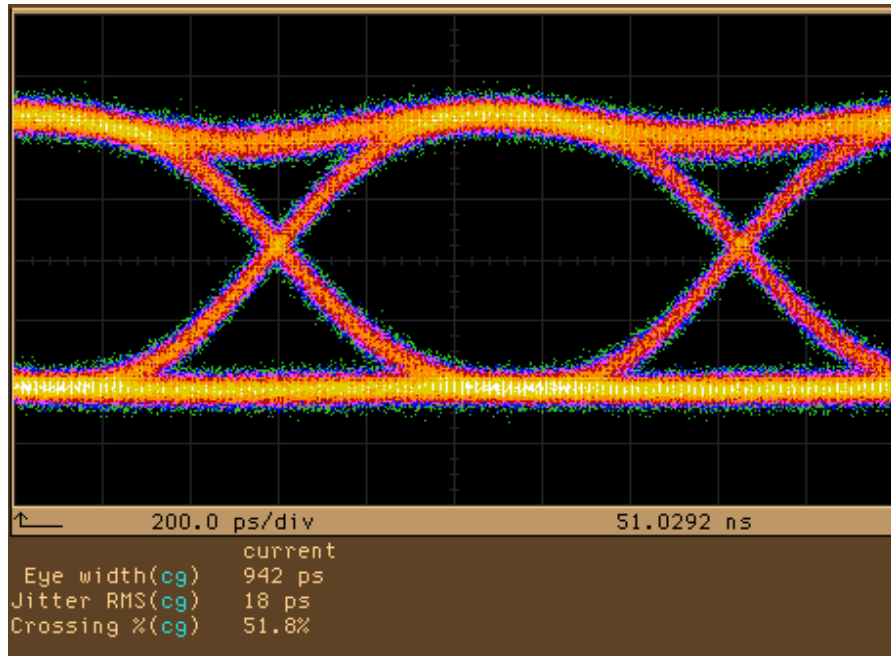


Receiver array with

- test output modulators
- receiver circuits (obscured by photodetectors)
- photodetectors

62.5 μm

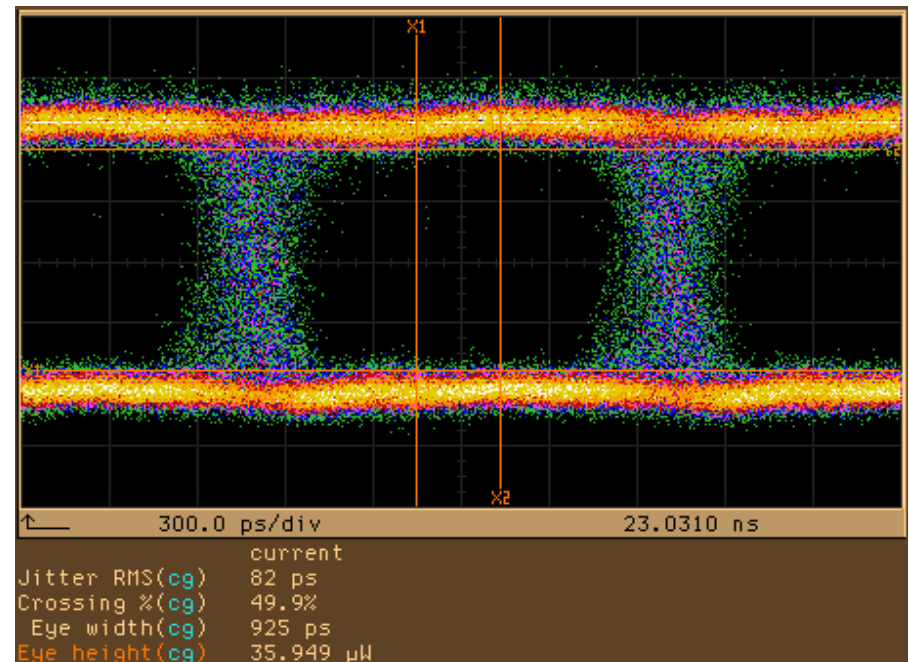
Device performance



950 Mb/s modulator
output with cw readout

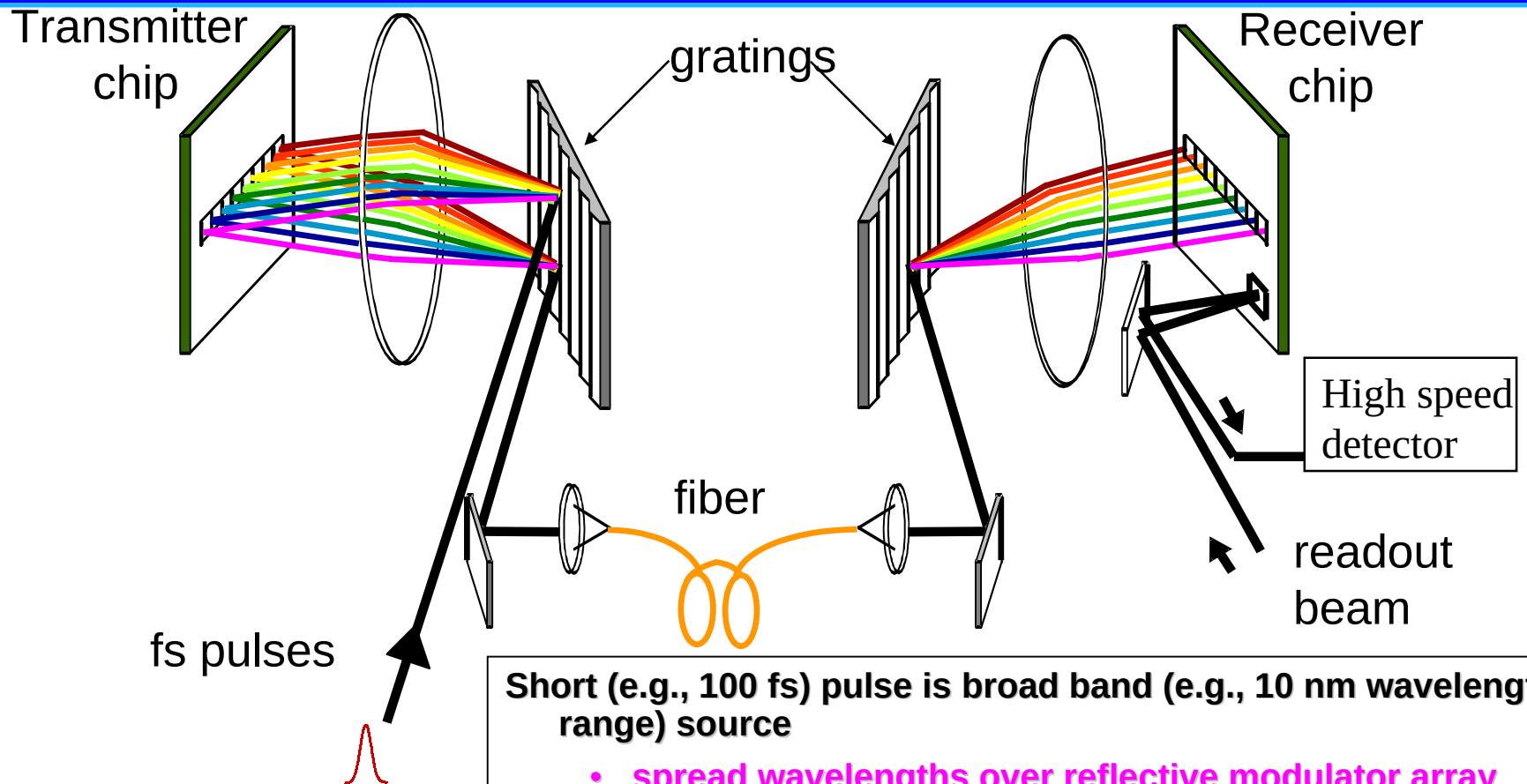


700 Mb/s receiver eye diagram
using cw laser drive (100 μ W
optical power per diode)



David A. B. Miller, Stanford

Short Pulse WDM Interconnect System



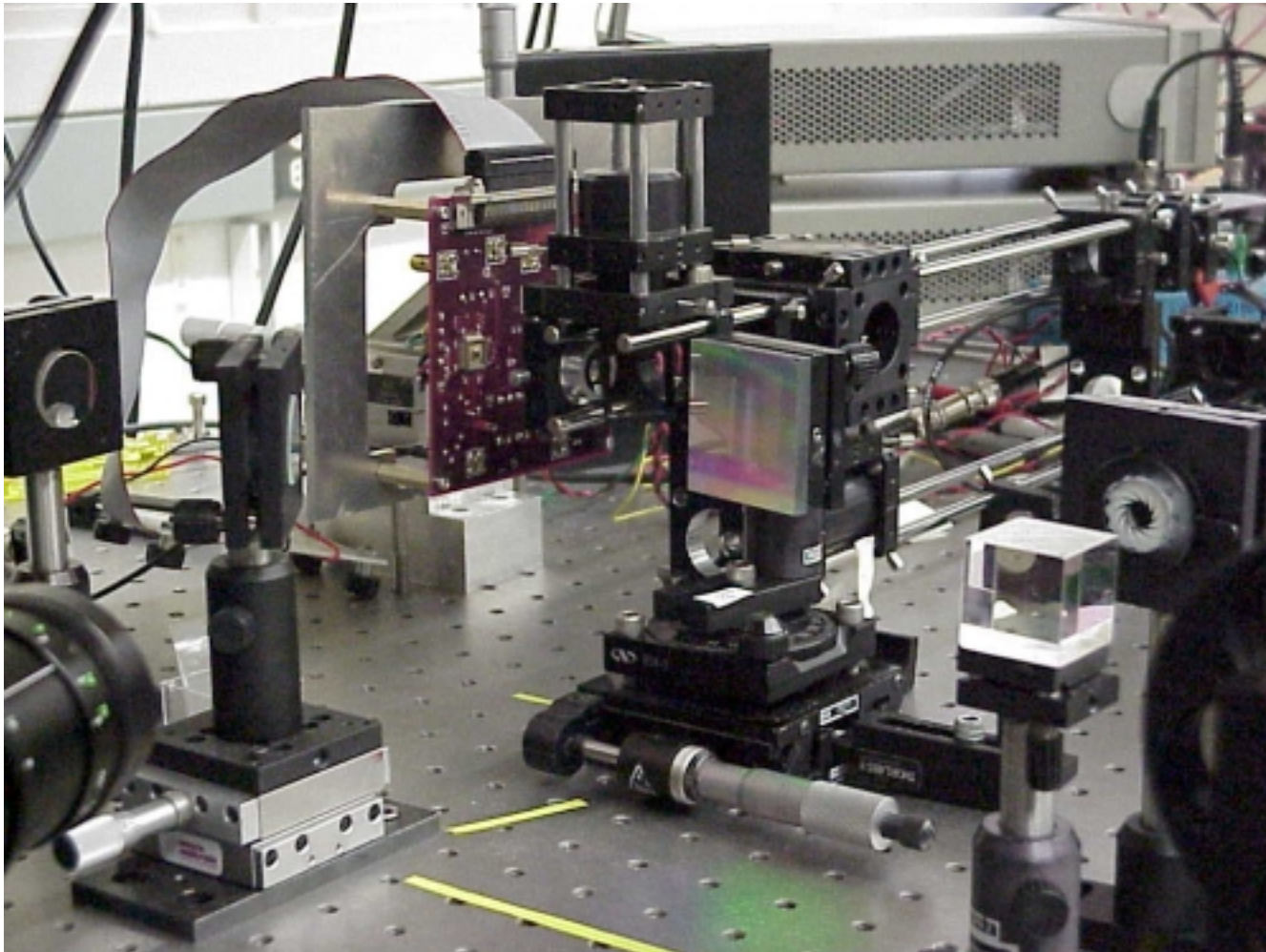
Short (e.g., 100 fs) pulse is broad band (e.g., 10 nm wavelength range) source

- spread wavelengths over reflective modulator array
- send reflected signals over single fiber to receiver array

Multiple channel interconnect with single fiber and single laser

David A. B. Miller, Stanford

WDM Interconnect Setup

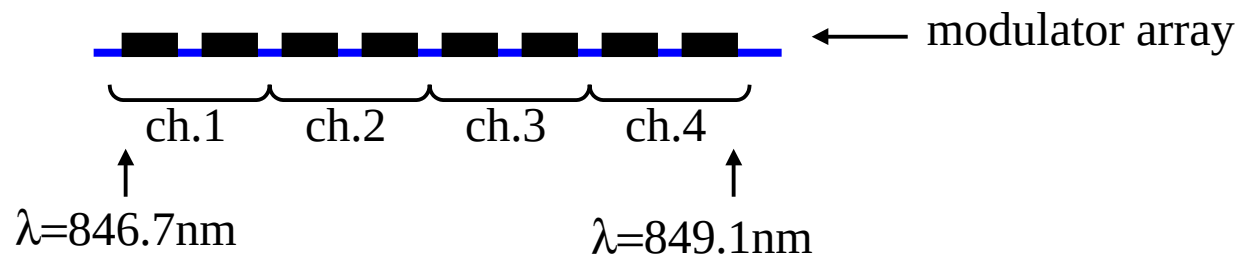
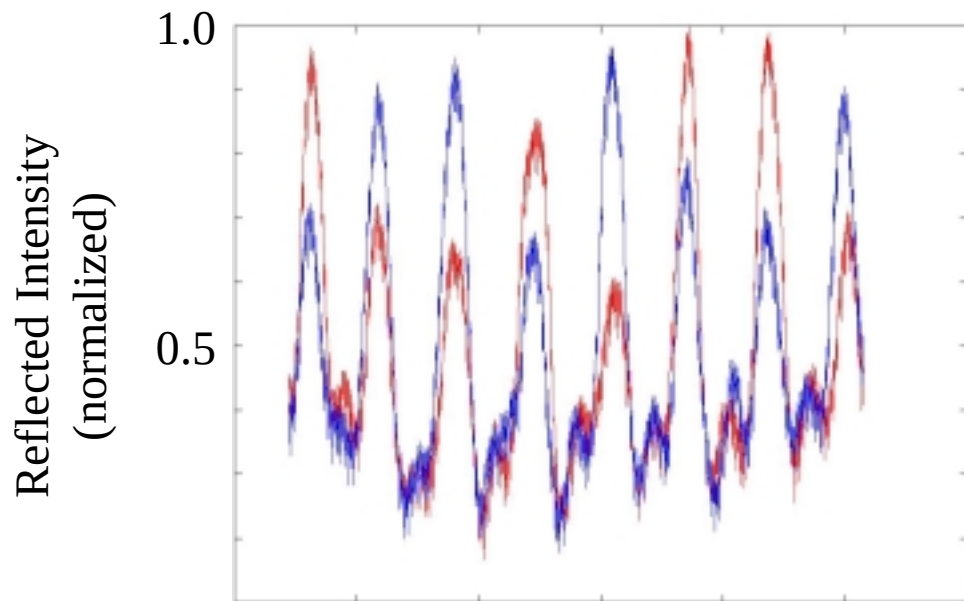


David A. B. Miller, Stanford

APPROVED FOR PUBLIC RELEASE, DISTRIBUTION UNLIMITED

Modulator Array Testing

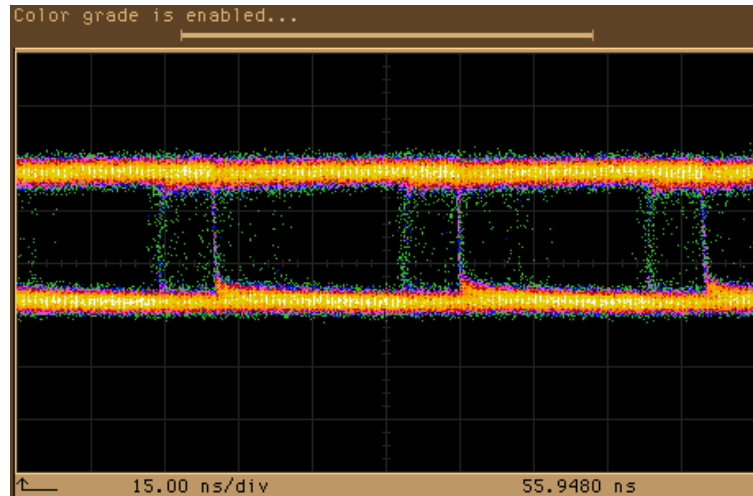
Modulator array output in Optical Spectrum Analyzer System



David A. B. Miller, Stanford

APPROVED FOR PUBLIC RELEASE, DISTRIBUTION UNLIMITED

Operation of WDM Interconnect



Receiver eye with optical readout

Entire WDM interconnect system operating at 20 Mbps

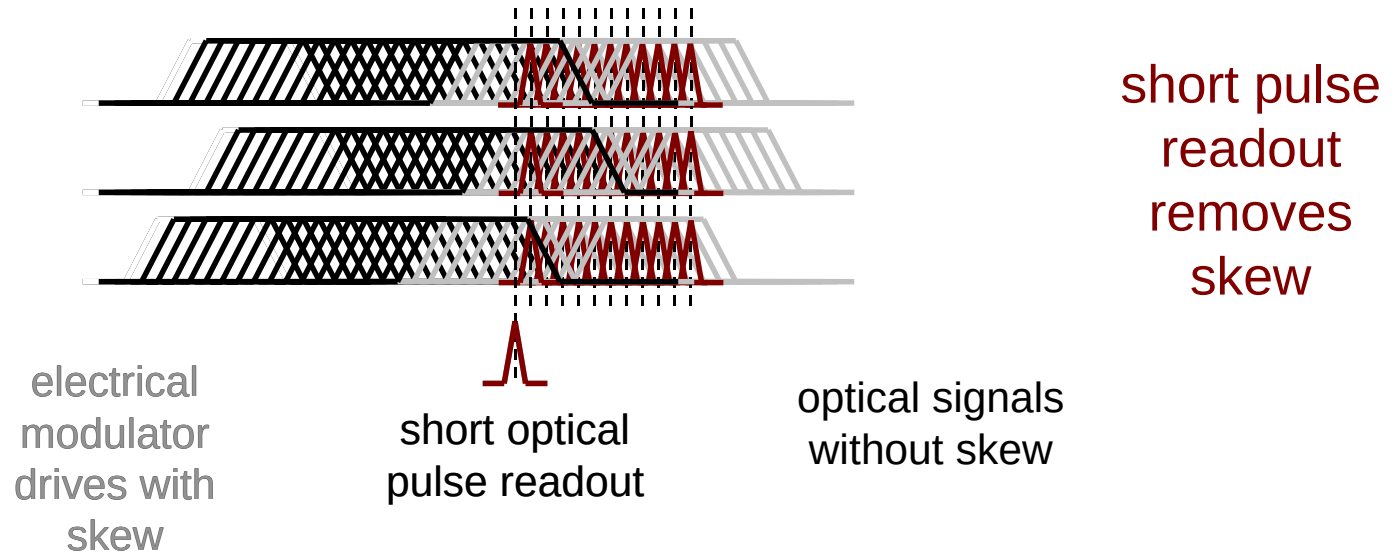
Key issues limiting system performance

- **insufficient uniformity in silicon receiver circuits**
 - *improved circuits now in fabrication*
- **simple bench-top optomechanics not sufficiently rigid**
 - *second generation optomechanics now under construction*

Features of short-pulse dense WDM interconnects to silicon chips

- avoids electronic multiplexing and demultiplexing
- uses single laser for multiple channels
- uses single fiber for multiple channels
- intrinsically synchronizes all channels
- exploits all other advantages of short pulse interconnects

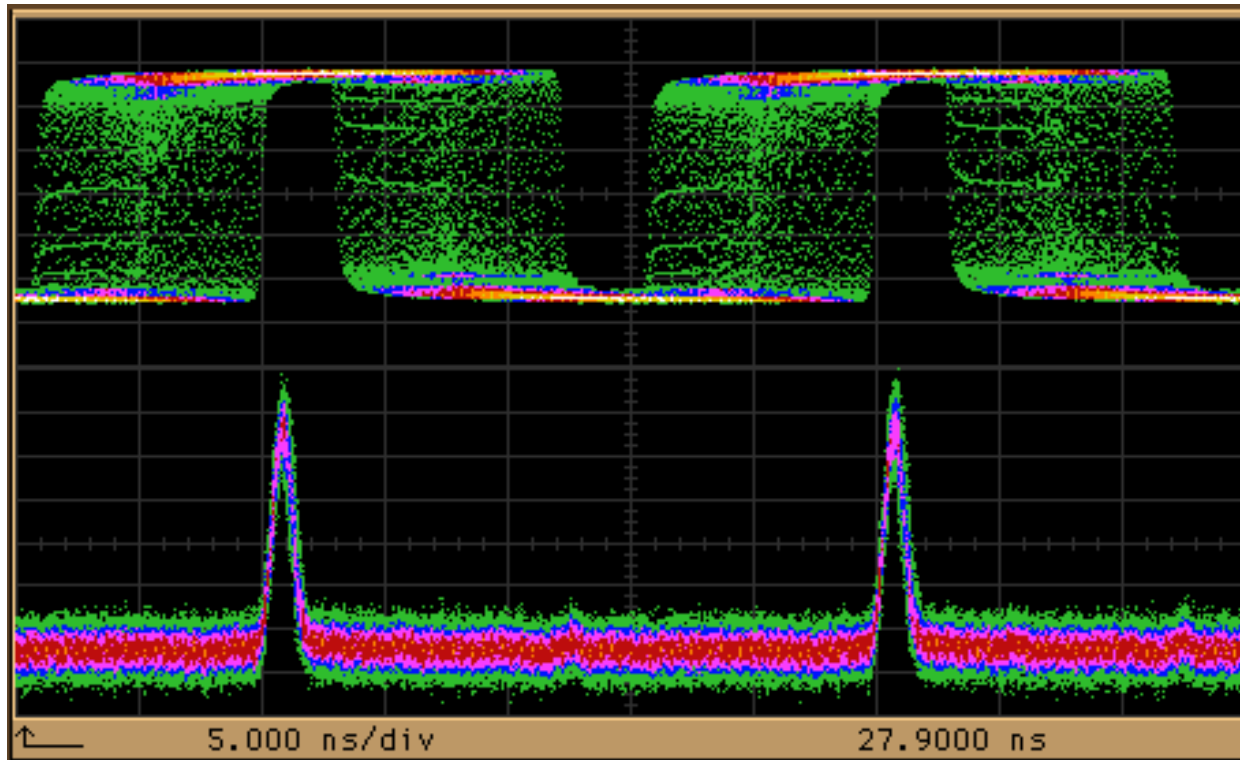
Removal of Skew By Using Short Pulses With Modulators



Effectively sampling the data on modulator

Up to one half bit of skew in modulator drive can be removed

Experimental Demonstration of Jitter Removal with Short Pulses



Electrical input
signal to modulator,
with jitter

Optical output signal
after reading out
with a short pulse,
receiving the signal,
and driving a
second modulator

D. Agarwal, G. Keeler, B. Nelson, D. A. B. Miller (Stanford)

**Demonstration of jitter removal from a single
interconnect channel, at a clock rate of 82 MHz.**

David A. B. Miller, Stanford

GaInAsN for Long-Wavelength Uniform Devices

Growth of this material by MBE shows

- **unity sticking coefficient of nitrogen**
 - *every nitrogen atom that lands on the surface incorporates, independent of growth rate*

contrasts with strong dependencies of InGaAsP growth on temperature and flux

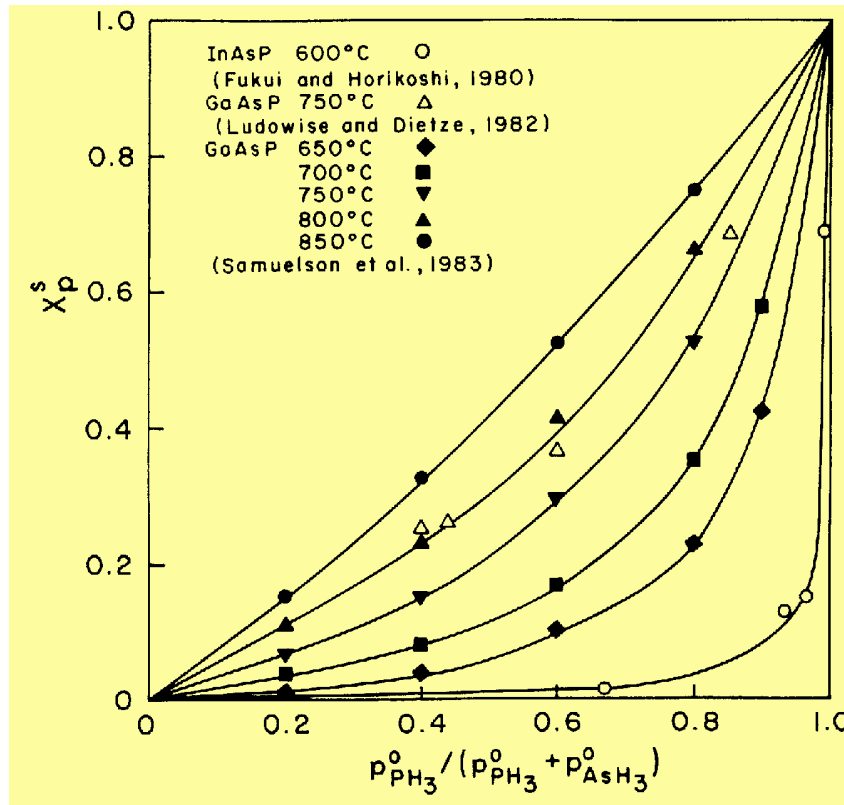
- **may allow uniform, reproducible growth of long-wavelength devices**

Allows use of GaAs substrates

Demonstrated 1.2 micron CW VCSEL

Possibilities for other, longer wavelength devices

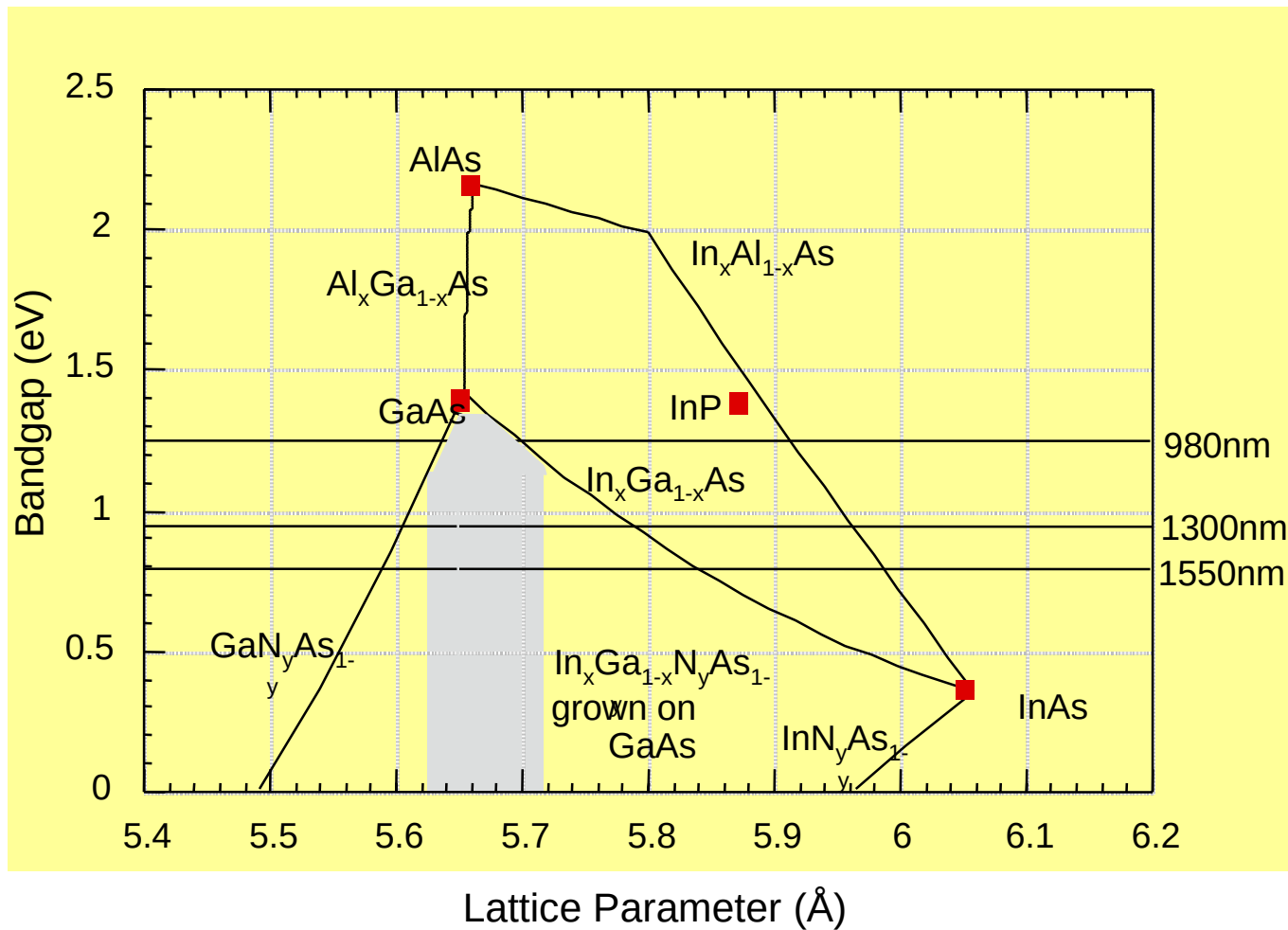
Group V concentration in Arsenide-Phosphides



Stringfellow
Organometallic Vapor-phase Epitaxy
Theory and Practice

Phosphorus concentration (x_P^S): dependent on temperature, dependent on AsH_3 and PH_3 flux because both kinetics (incomplete pyrolysis of the hydrides) and thermodynamics determine concentration.

Bandgaps of III-V Alloys



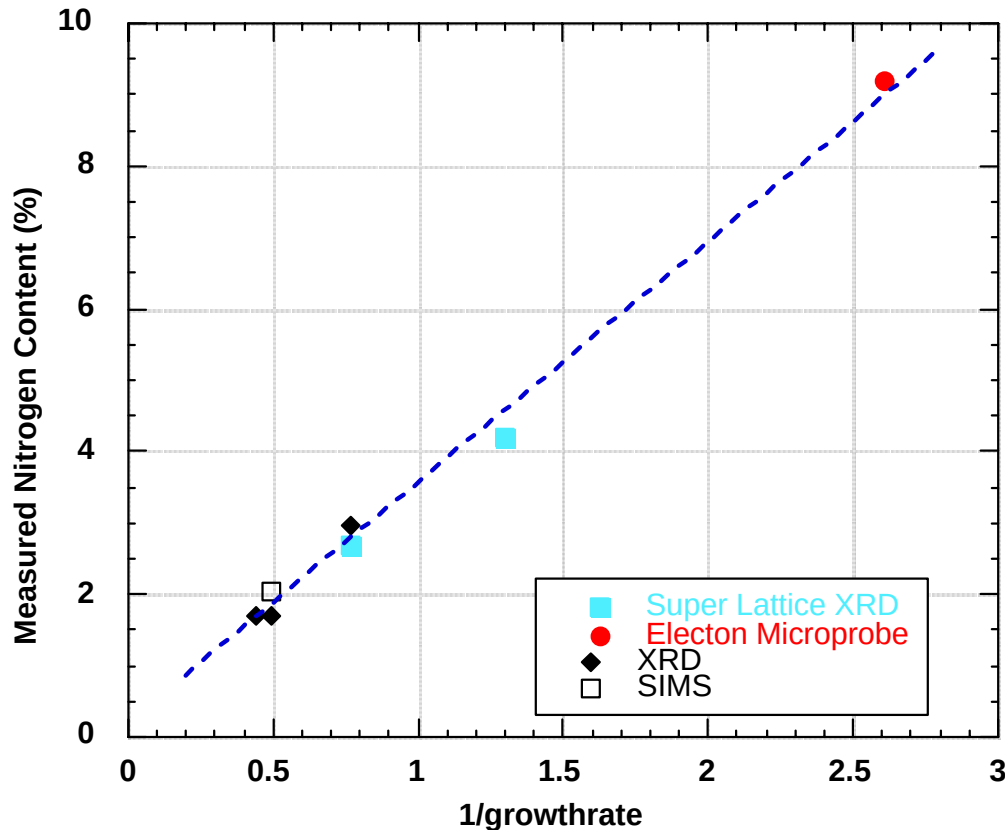
N causes bandgap of GaAs to decrease rapidly.

N is small and In is big $\Rightarrow$ strain can be tuned from tensile to compressive when grown on GaAs.

David A. B. Miller, Stanford

APPROVED FOR PUBLIC RELEASE, DISTRIBUTION UNLIMITED

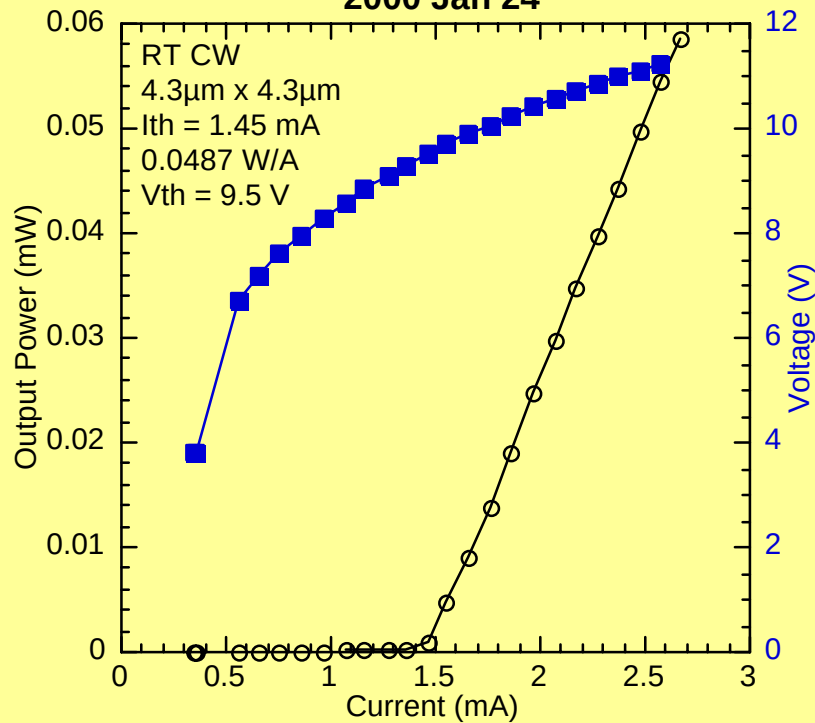
GalnNAs Elemental Source MBE



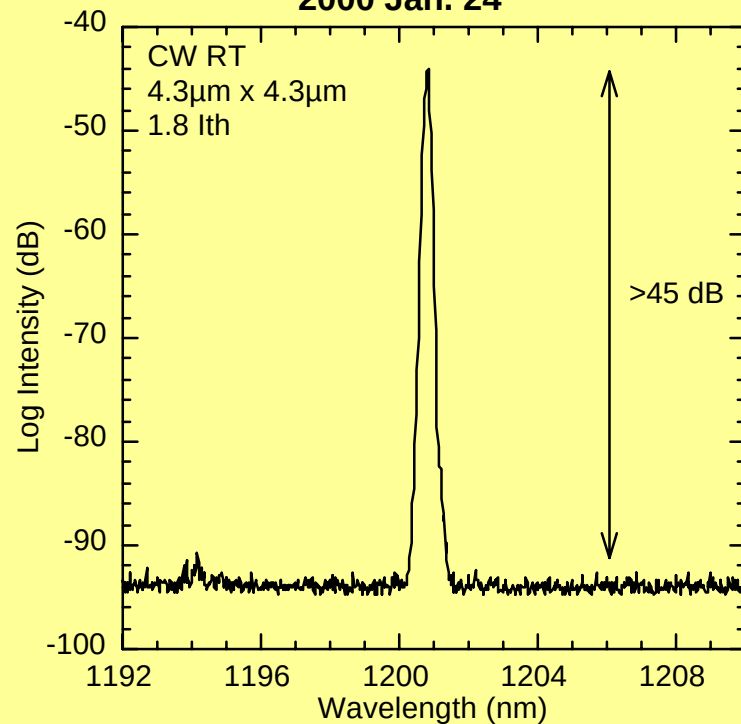
- Low substrate temperature avoids phase segregation
- Atomic Nitrogen sticking coefficient ~ 1 (N mole fraction = $1/\text{growth rate}$)
- Hence expect uniform, predicable growth of this material

CW operation oxide-confined VCSEL

GalNAs oxide-confined VCSEL 0.1,0#1 CW LIV
2000 Jan 24



GalNAs oxide-confined VCSEL Spectrum
2000 Jan. 24



Ultrafast Optoelectronic Gate

Device concept

trigger top diode to give rise to temporary local voltage change in bottom diode

voltage change in bottom diode gives temporary change in absorption, modulating beam

Optically-controlled optical gate to transfer data from one beam to another (e.g., different wavelengths)

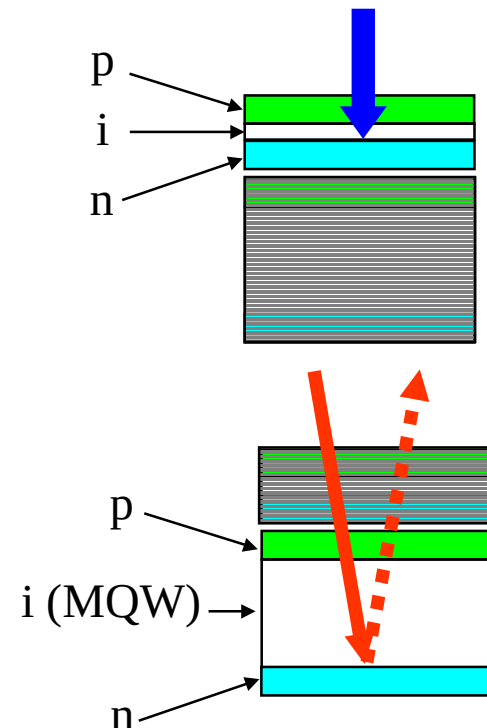
Electrically controlled - only works when diodes are biased

Top Diode

- Thin intrinsic region
- $\text{Al}_{0.3}\text{Ga}_{0.7}\text{As}$, transparent at $\sim 850\text{nm}$

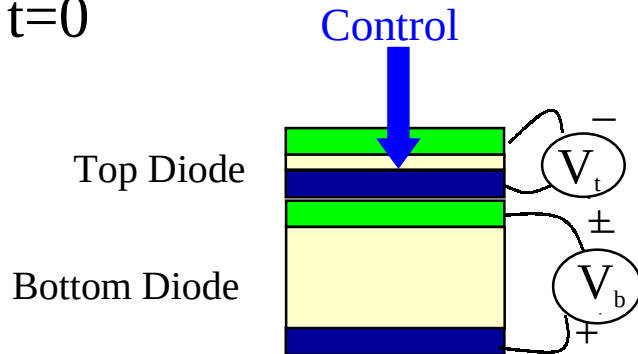
Bottom Diode

- Thick intrinsic region
- GaAs multiple quantum wells voltage-sensitive at $\sim 850\text{nm}$



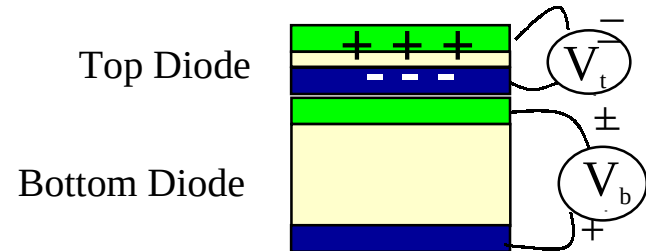
Basic Design Concept

(1) $t=0$



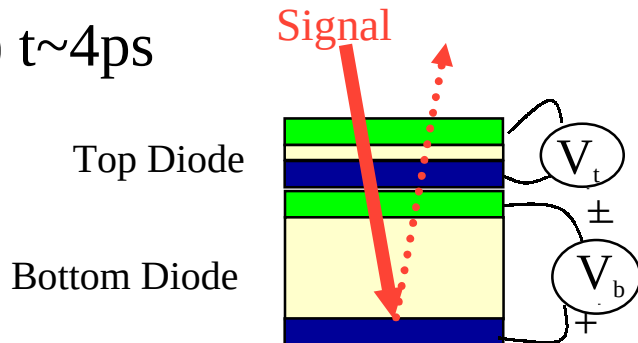
Control pulse is absorbed in top diode

(2) $t=0-4\text{ps}$



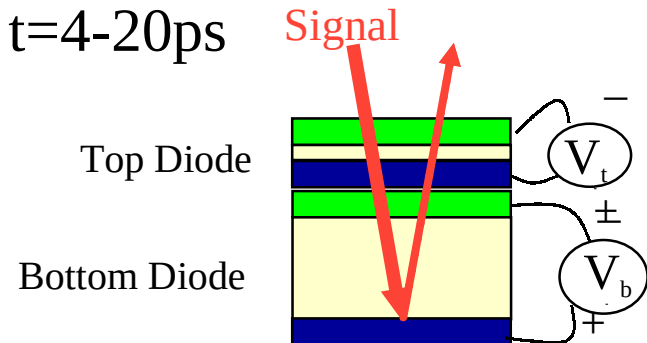
Due to separation of photogenerated carriers, voltage builds up, shielding the bias

(3) $t\sim 4\text{ps}$



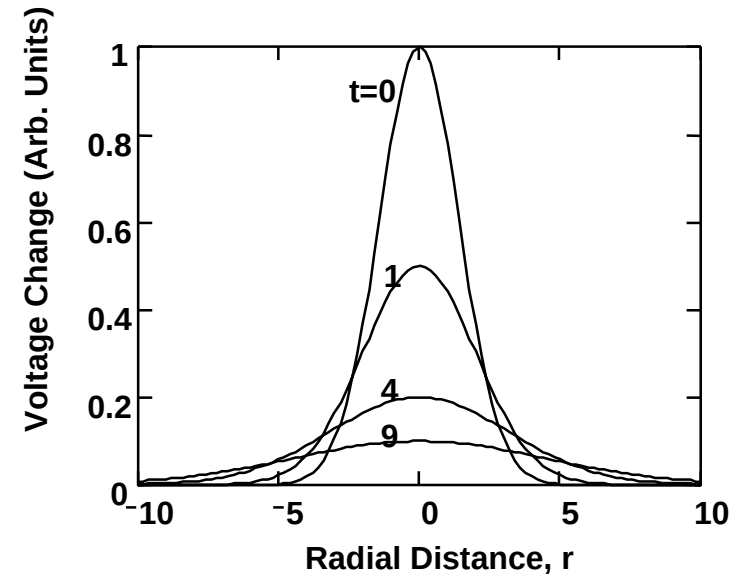
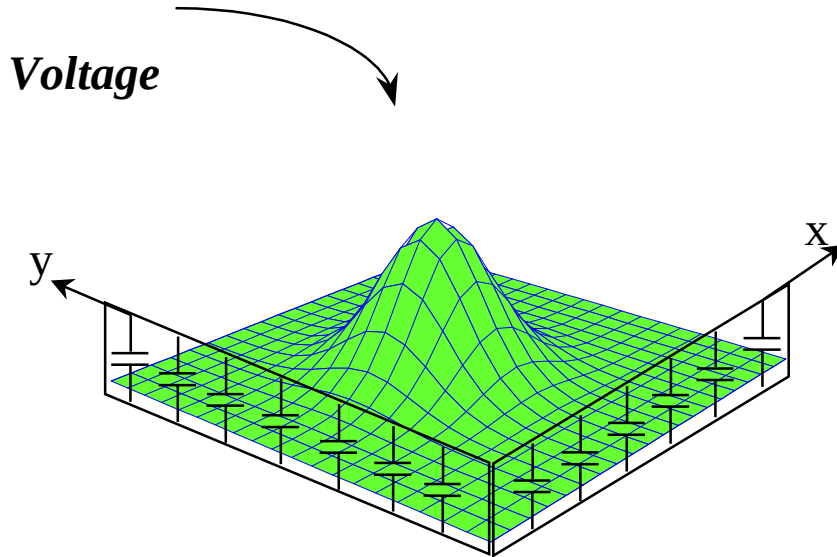
Voltage build-up changes absorption level in bottom diode: ON

(4) $t=4-20\text{ps}$



Voltage build-up decays away: OFF

Diffusive Conduction



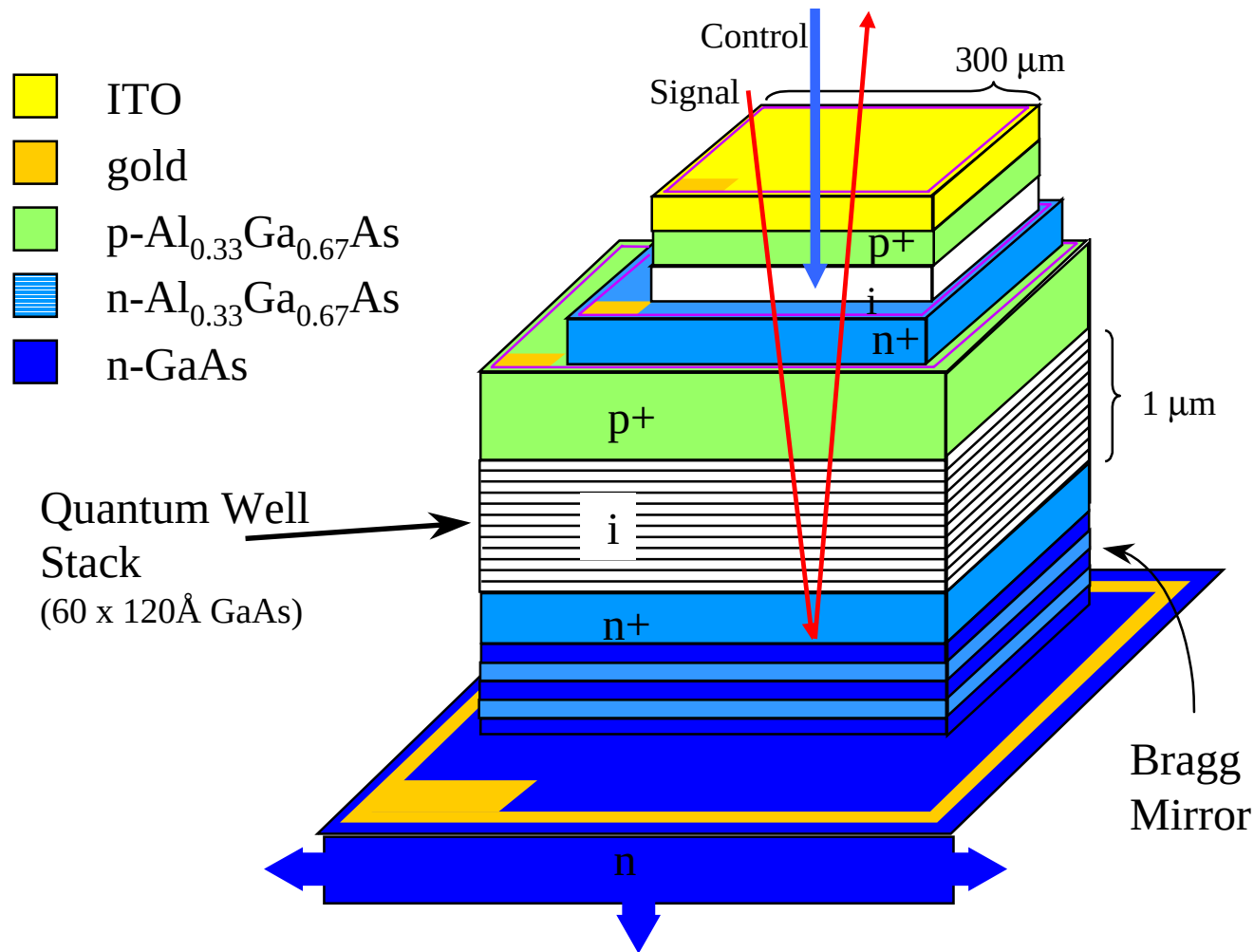
$$\frac{dV}{dt} = D \nabla_{xy}^2 V$$

$$D = \frac{1}{R_{SQ} C_A}$$

R_{SQ} = Resistance per square

C_A = Capacitance per unit area

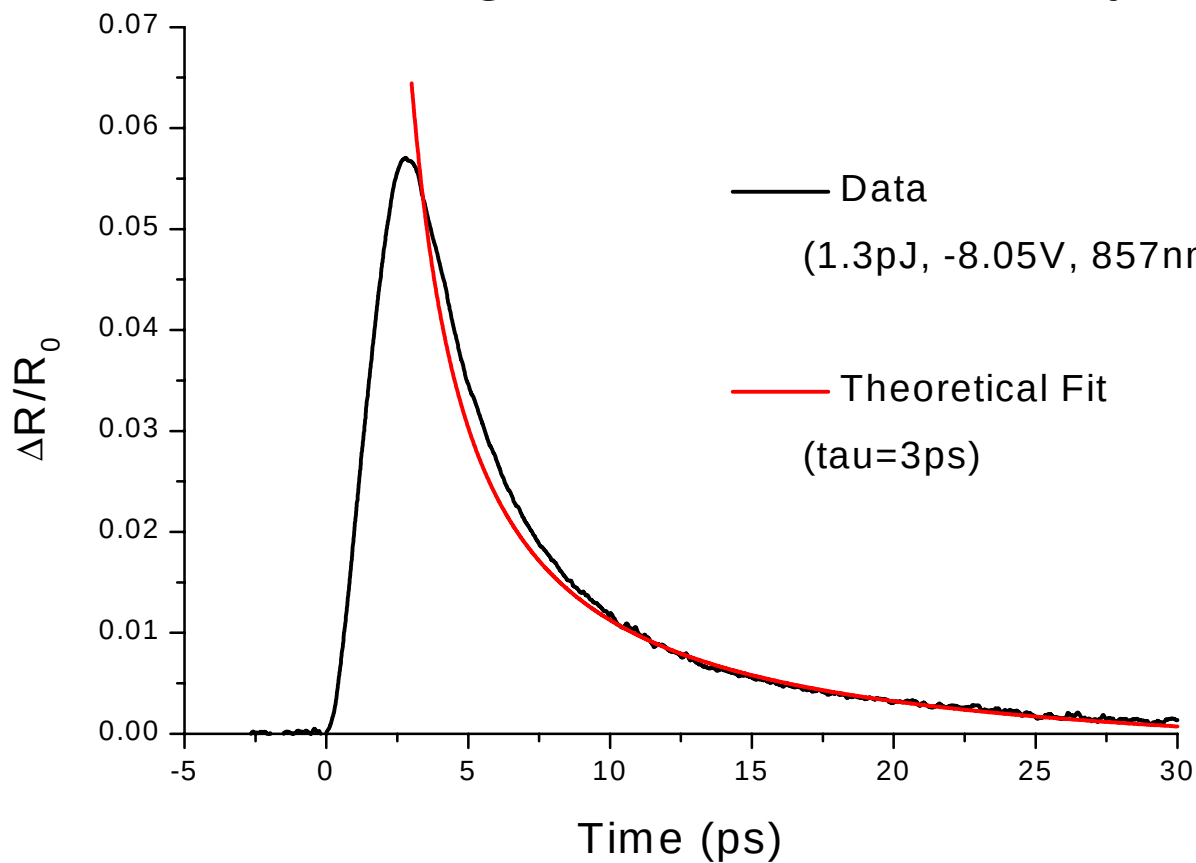
Device Structure



David A. B. Miller, Stanford

Results

Change in Relative Reflectivity



David A. B. Miller, Stanford

Results: Large Signal Response

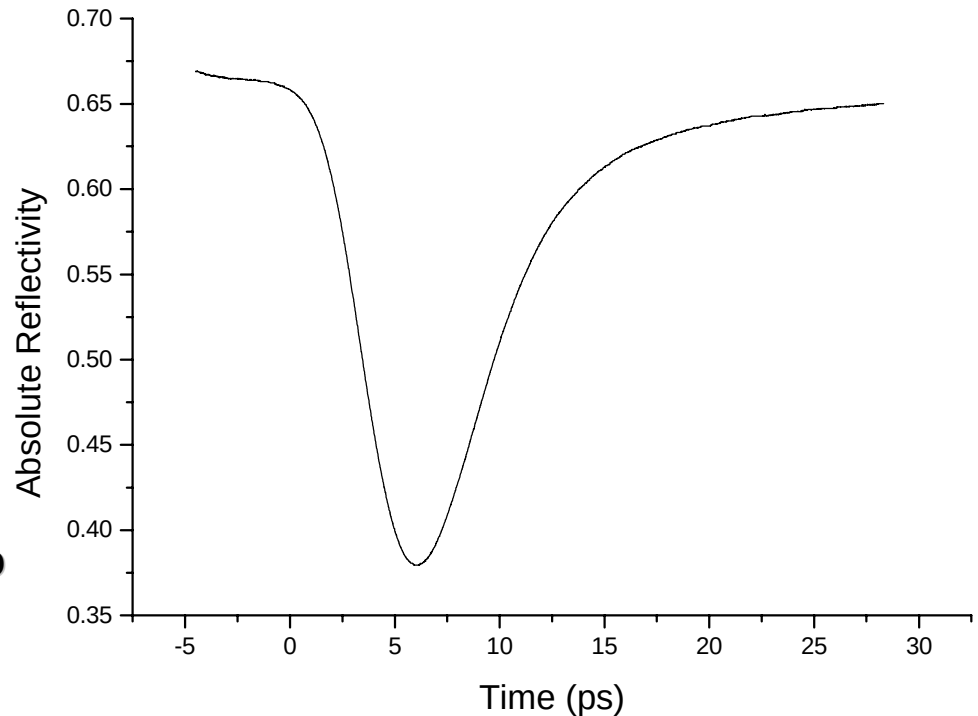
Description:

- 3.5 μm spot radius
- 1.5 pJ/pulse
- 39 fJ/ μm^2
- 2 ps pulse width

20 ps FW-10%M

30% Reflectivity Change

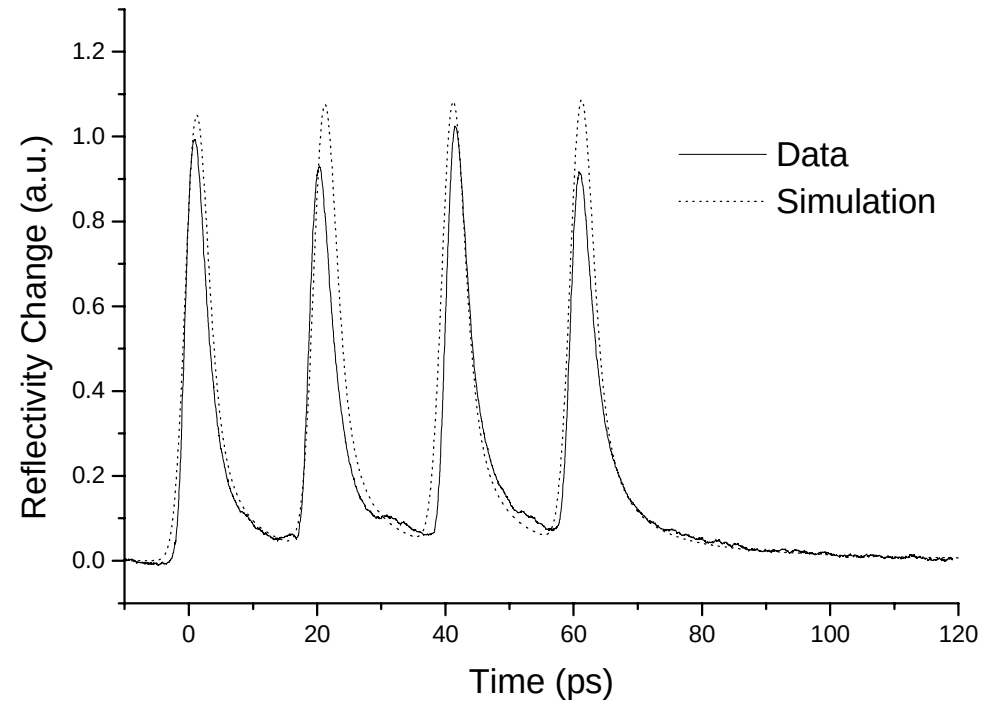
Nearly 2-to-1 Contrast Ratio



Results: Pulse Repetition Response

Description:

- 3.5 μm spot radius
- 20 ps pulse separation
- 2 ps pulse length
- ~ 70 fJ/pulse



Conclusions

WDM interconnect between silicon chips successfully demonstrated

Synchronization of signals using short optical pulses

GaNAsN promising material for uniform long-wavelength devices, with cw VCSEL demonstrated

Ultrafast optically controlled optical gate may allow fast, digital, electrically-controllable wavelength converting and switching devices